

Printing Metals and Light Absorbing Ceramics, using the DLP method

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March 2016

ECN-L--16-015





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Additive World 'Industrial 3D Printing Conference'

Jan Opschoor

Eindhoven
22 March, 2016

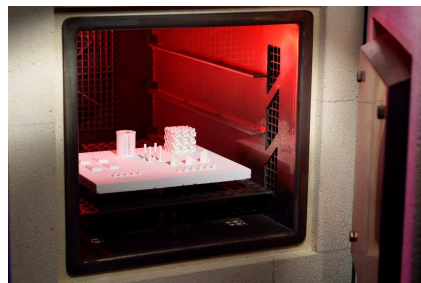
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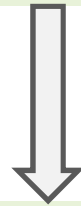
Why DLP AM for metals and light absorbing ceramics



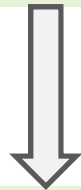
Using the strengths of the Powder Metallurgy (PM) basic process



blending



shaping



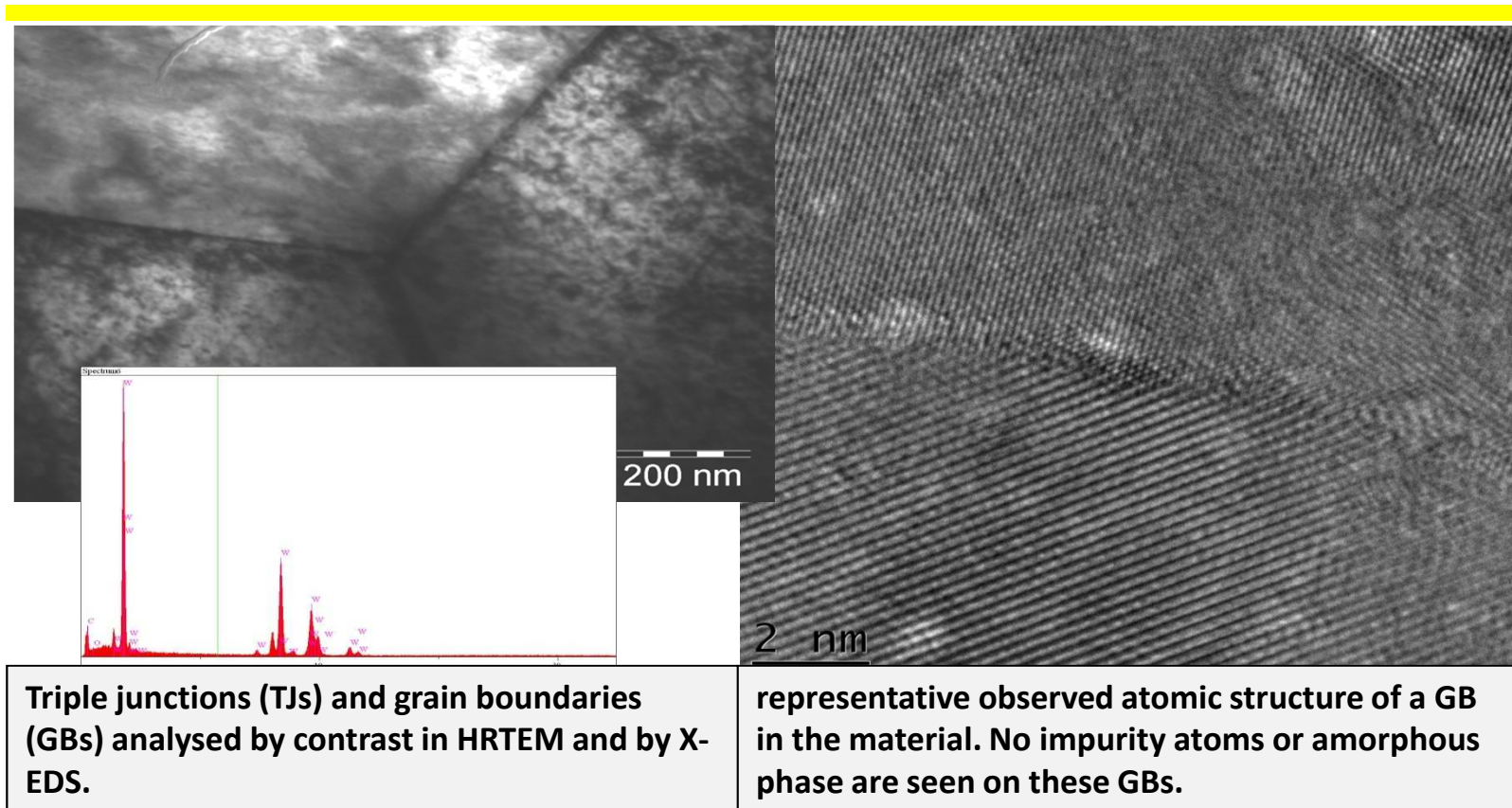
sintering

- Particle size, distribution, shape
- Impurities
- Homogeneity
- Stability
- Strength green product
- Sintering dopes
- Sintering ambient, Temp
- Density / porosity

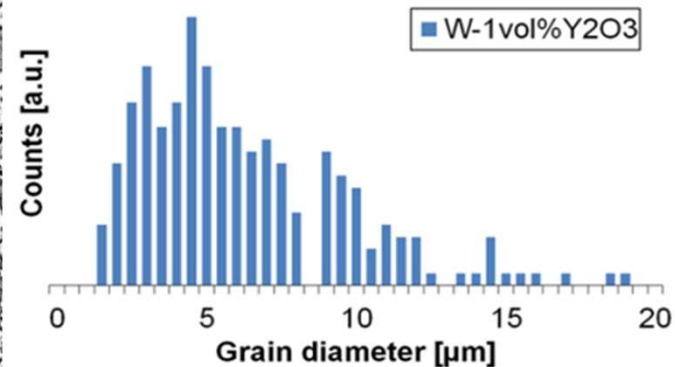
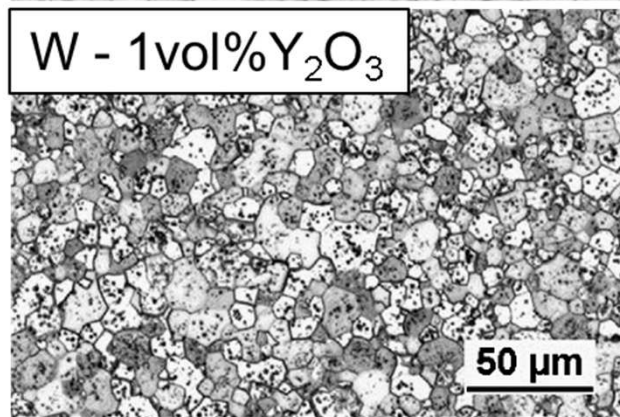
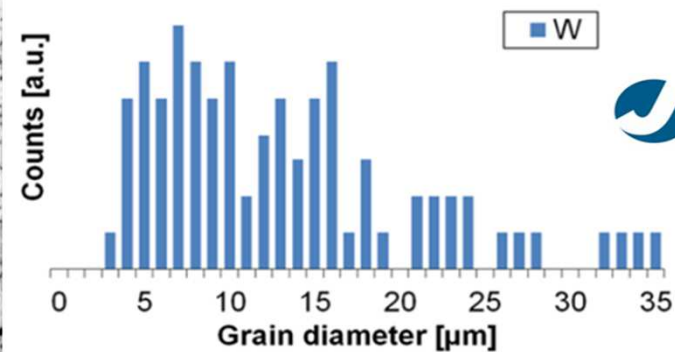
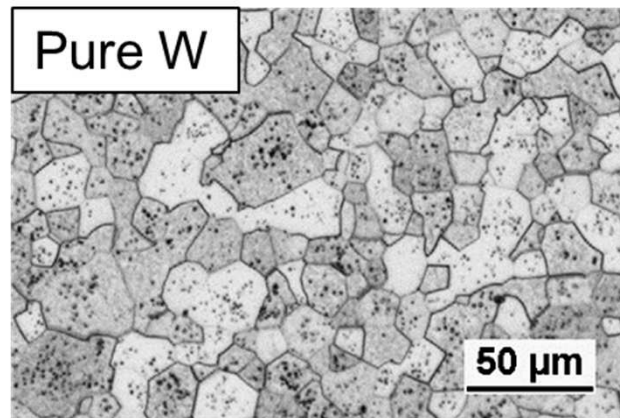
Advantages of PM based DLP technology

- Isotropic properties and microstructure
- Stress free material
- Segregation free
- Ultra high purity materials
- Flexibility by unique alloying/doping

High Resolution TEM of pure W

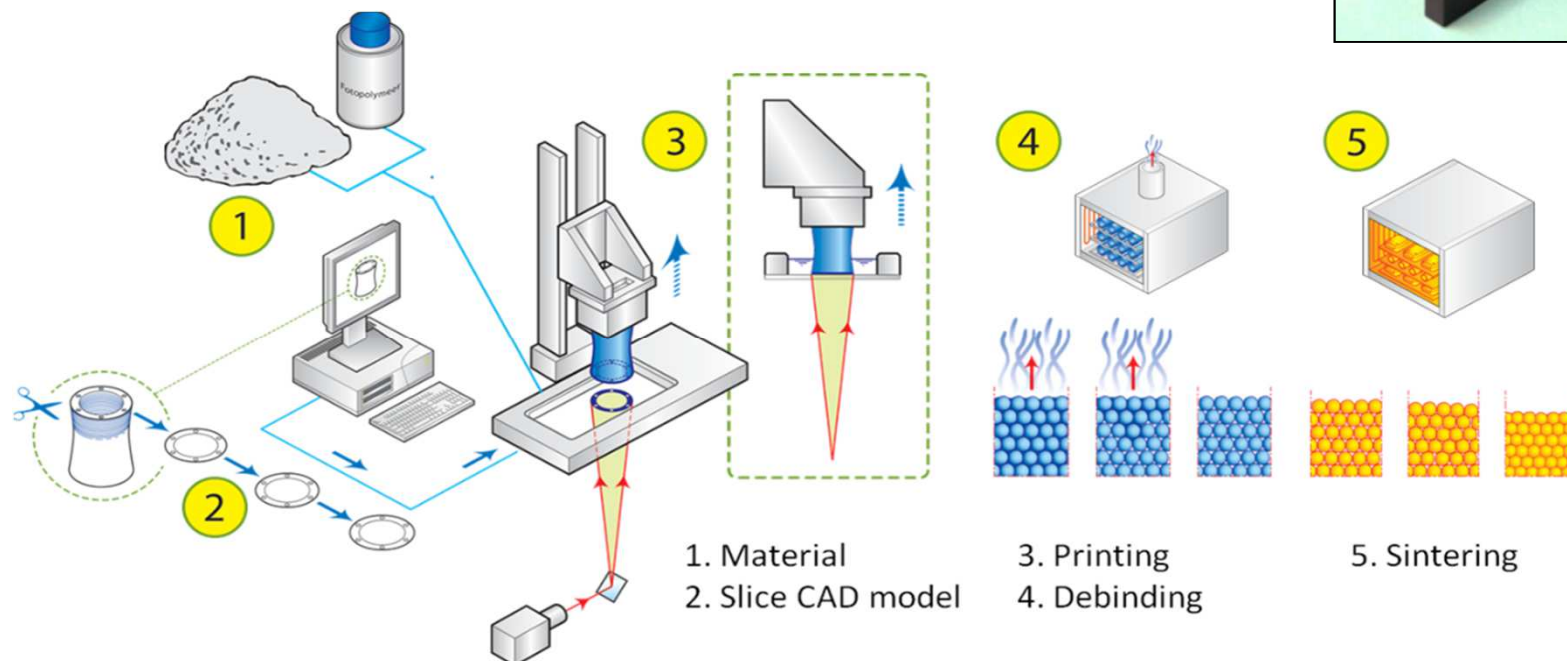
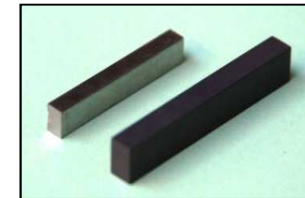


Controlled Microstructure by doping alloying (MIM W by ECN)



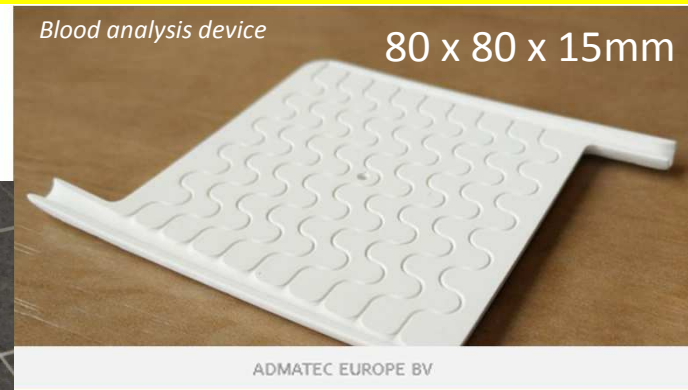
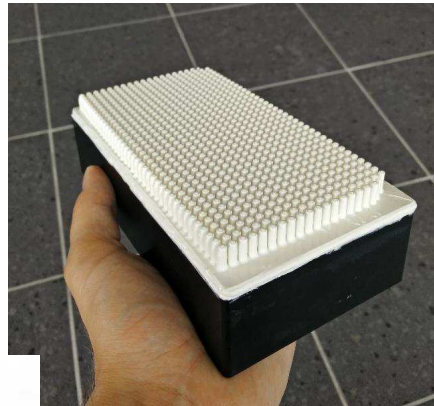
DLP (of Metals) basic proces

- Indirect, slurry based process



“Proven” Technology for oxidic ceramics

- Ceramic Materials
 - Al_2O_3 & ZrO_2
- High Quality,
 - small features,
 - accurate details
 - low roughness

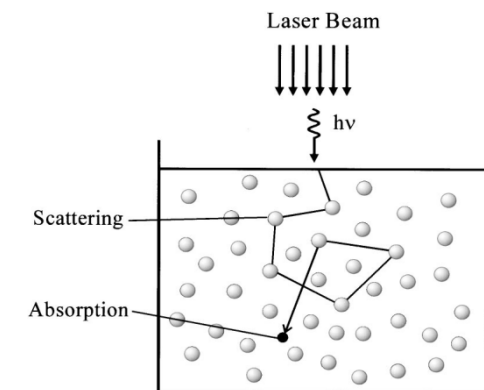
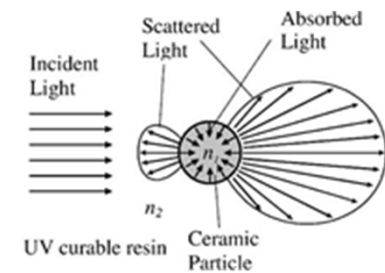
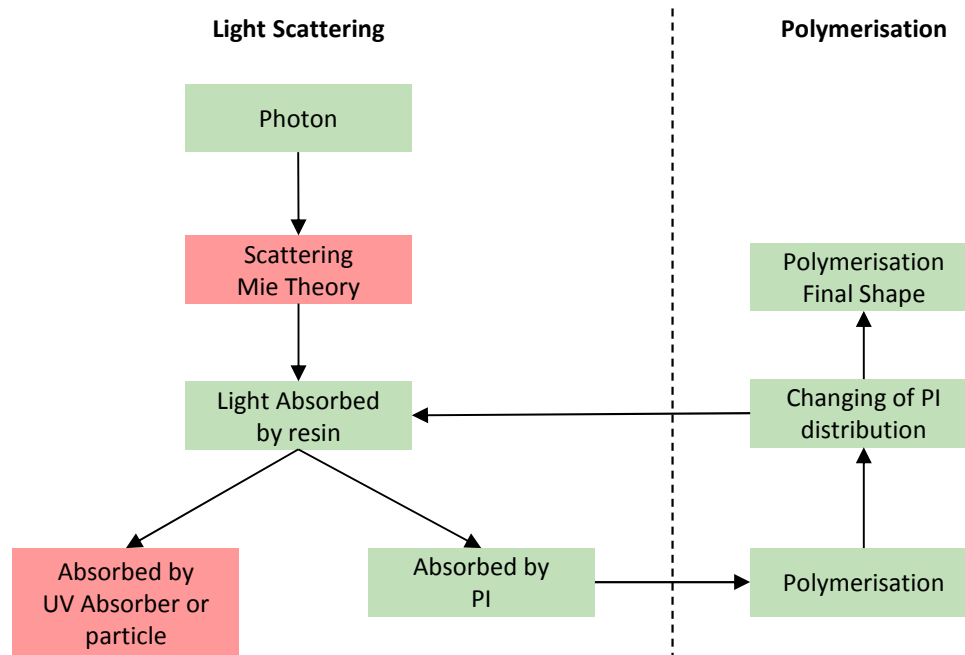


Possible next steps for micro reactors



Limitating material properties

- Absorbption & Light Scattering

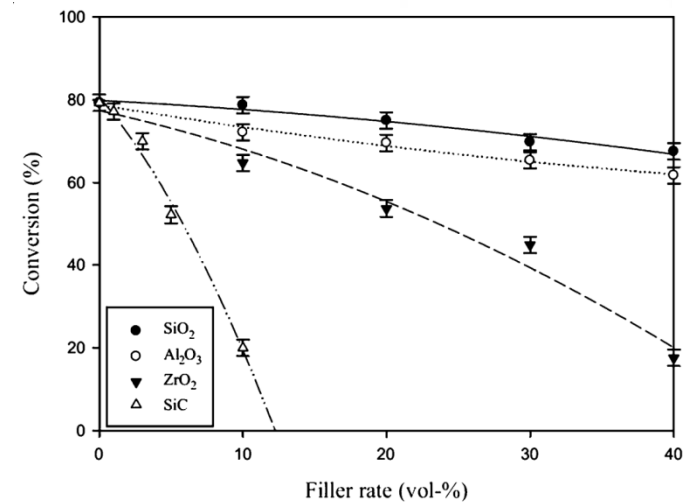
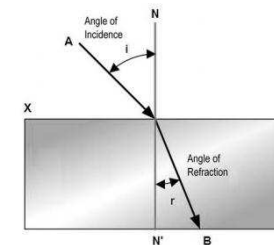


Mismatch in refractive Index

- The higher refractive index difference between particle and resin, the stronger the light scattering. (Less cure depth)

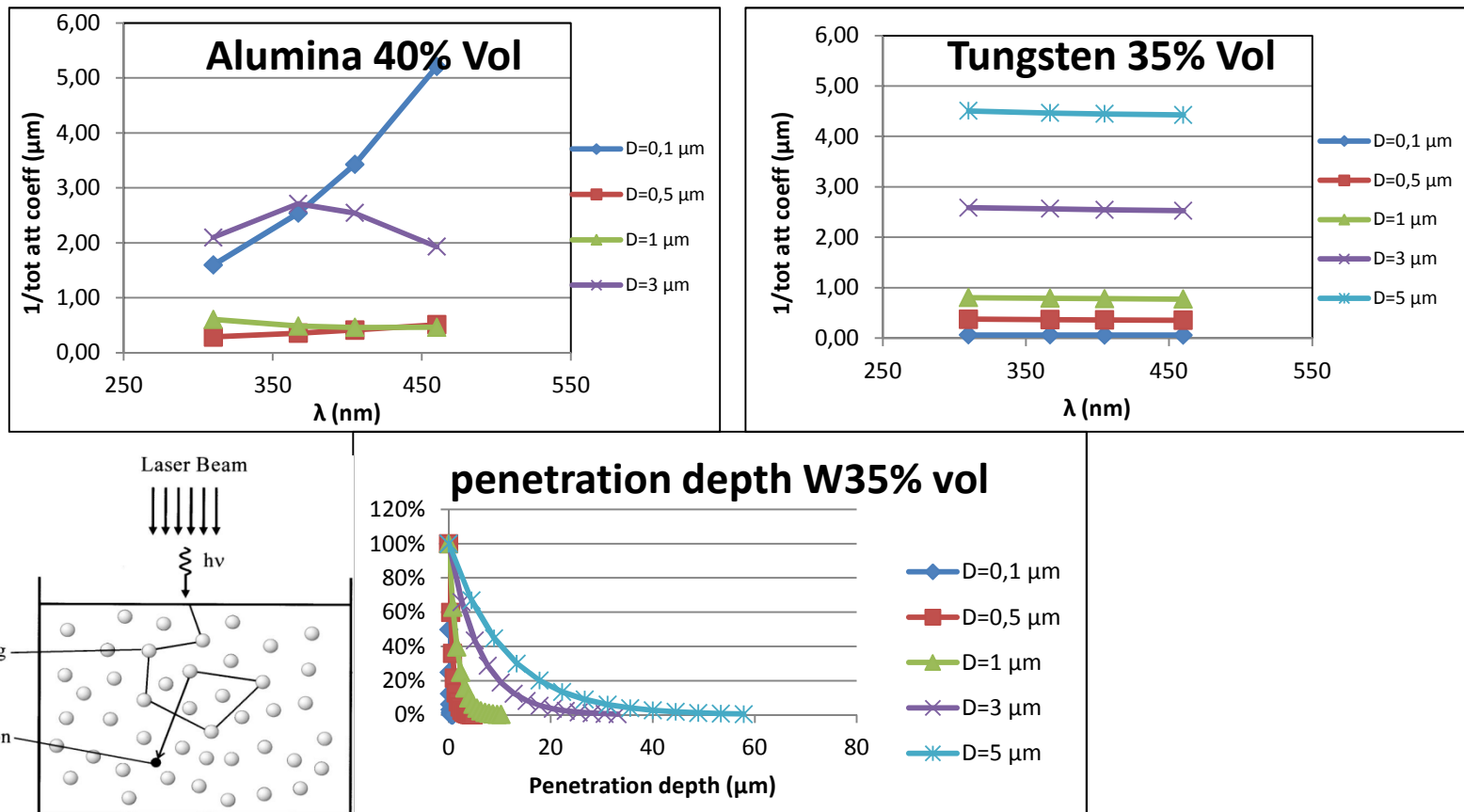
More difficult to cure

Material	Refractive Index n @ 437 nm	Im. Refractive Index n
Resin	1,46	0
SiO ₂	1,47	0
Al ₂ O ₃	1,7	0
ZrO ₂	2,25	0
SiC	2,69	0,7
Steel	2,48	2,6
W	3,41	2,6



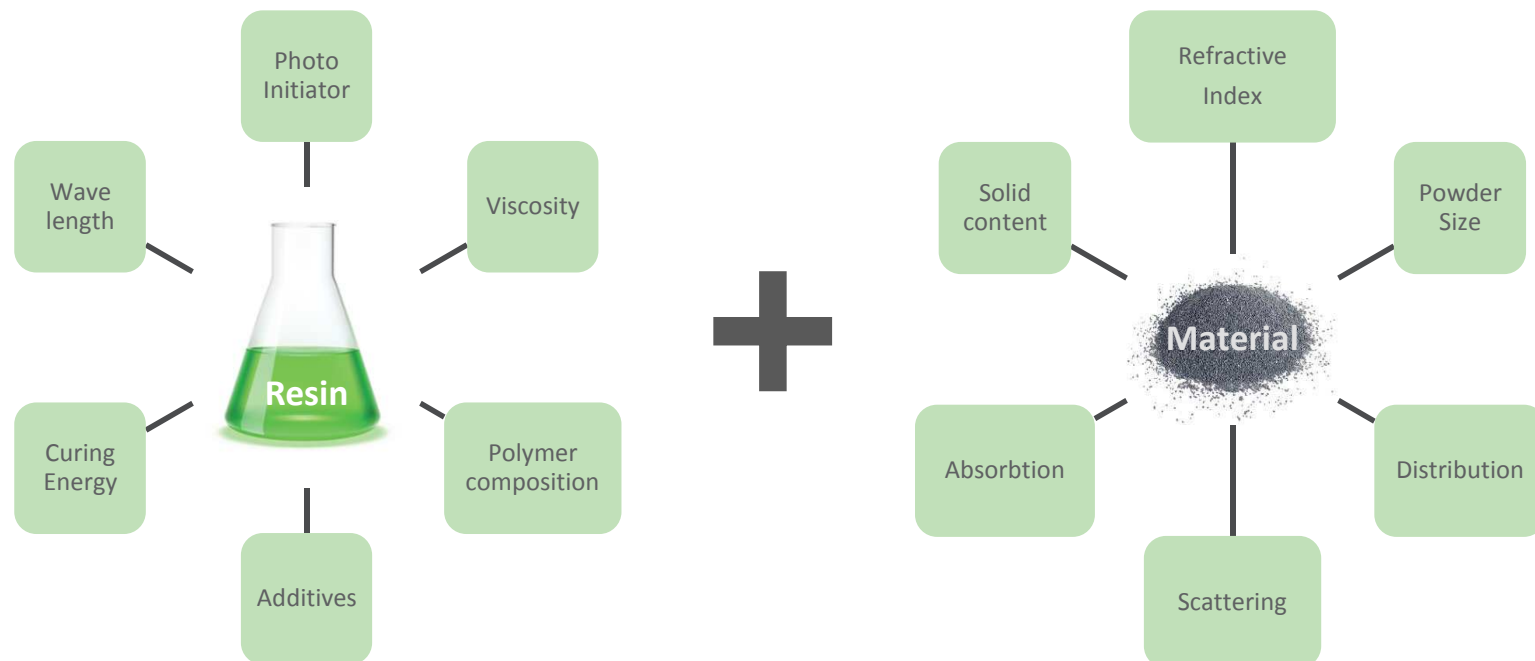
Influence of the refractive index and solid loading of ceramic filler on the polymerisation conversion of a acrylate filled resin 9

MIE scattering



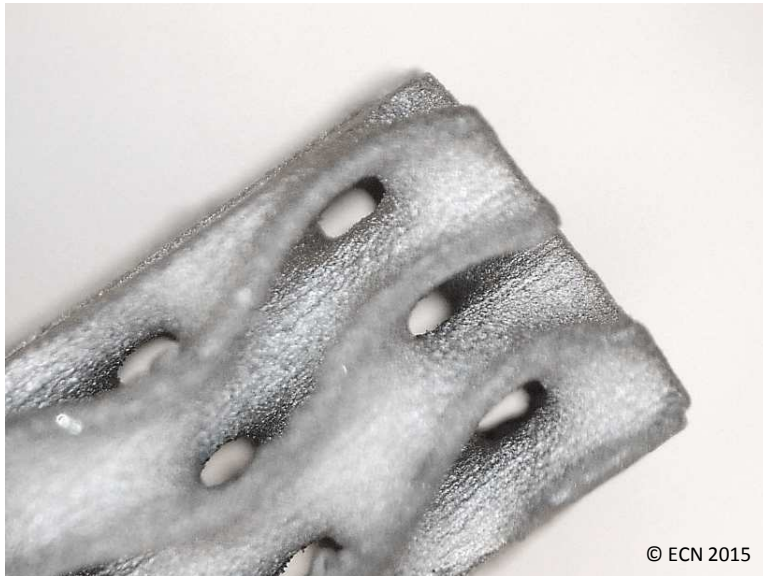
To be succesfull...

- Preparing a “dedicated” slurry to match your process is key.



316L gyroid

- Sintered 316L part
 - Size: 5x5x10 mm



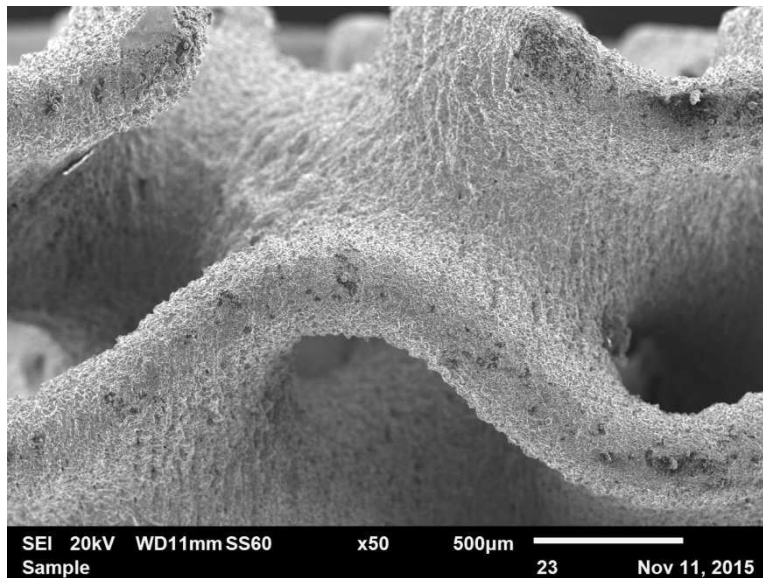
Detail of 3D printed geometry - sintered



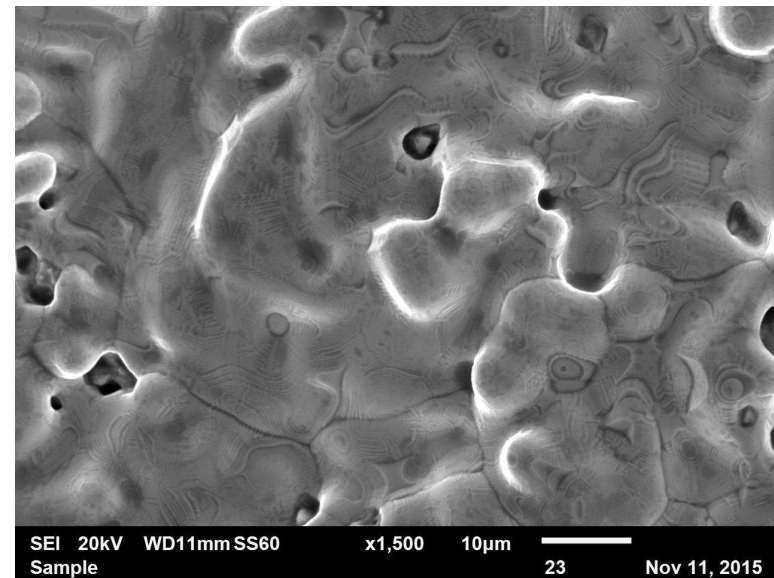
3D printed geometry - sintered

316L gyroid

- Sintered 316L part
 - Micro Structure

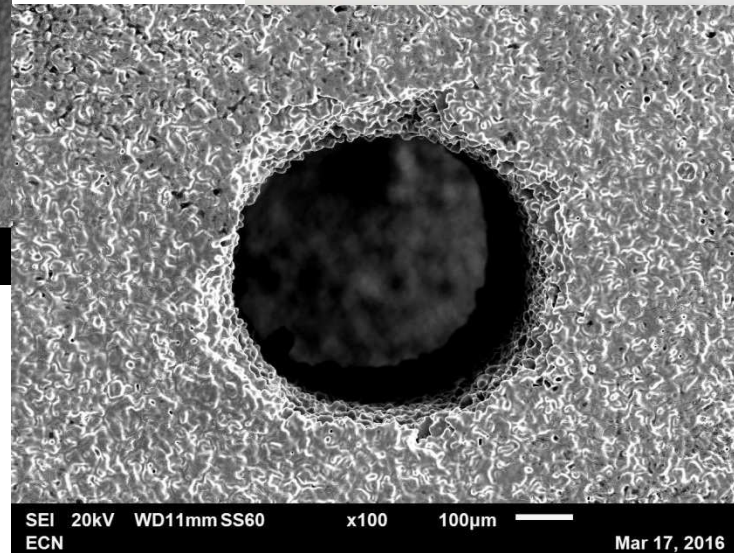
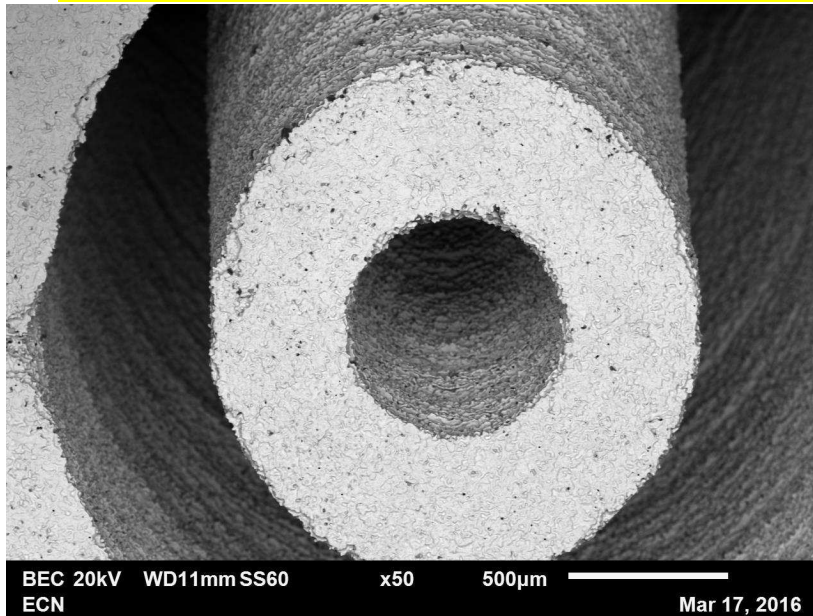


Detail of 3D printed geometry - sintered

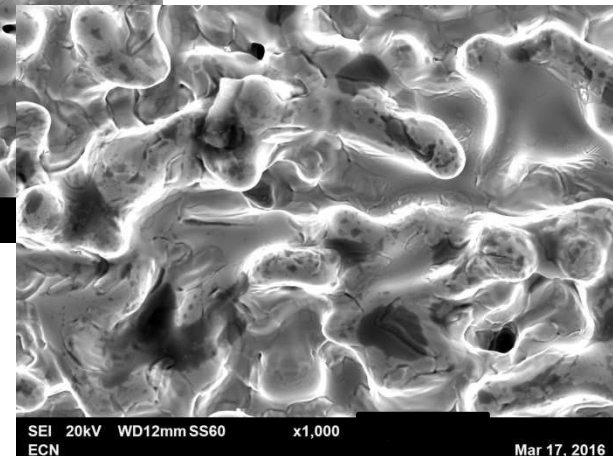
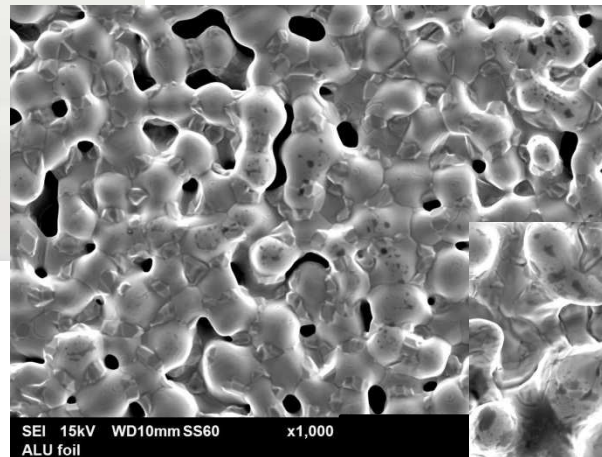


3D printed geometry - sintered

Printed details



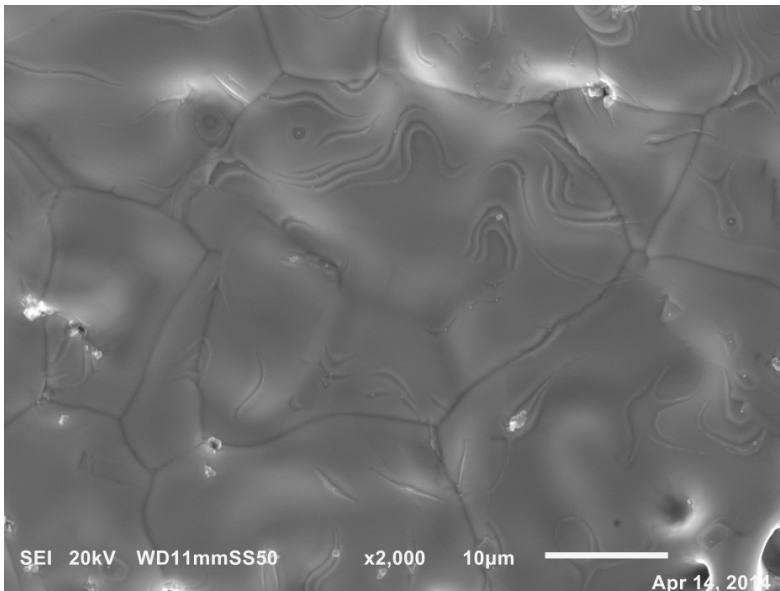
Sintering process 316L



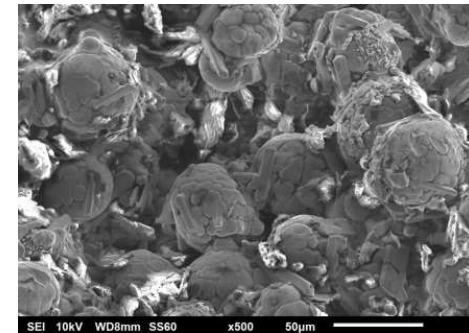
Higher sintering temperature

Comparison with other AM techniques

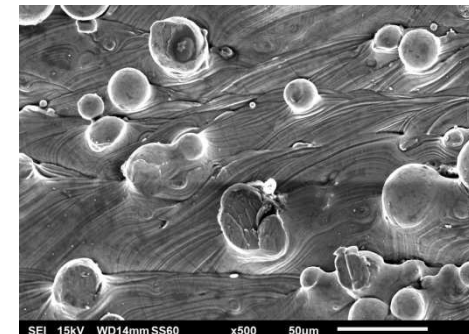
- Without post processing
 - Perpendicular to build direction.



*Photo Polymerisation 316L Sintered - ECN
(Indirect Process)*



*Binder Jet - ExOne
(Indirect Process)*



*Powder Bed Fusion
(Direct Process)*

Metal Printing ECN: indirect and also direct

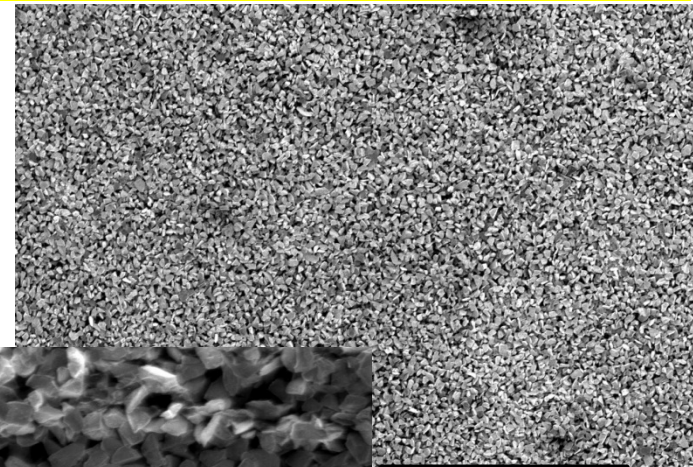


Indirect method	Direct method
Pro - <i>Isotropic high quality structure</i> - <i>Complex features possible</i> - <i>Low cost printing equipment</i> Contra - <i>Separate densification process</i> - <i>Shrinkage</i> - <i>Build speed lower than ceramics</i> Patents - <i>Pending 3x</i> - <i>Assigned 1x</i>	Pro - <i>Direct</i> - <i>Low stress compared to SLM</i> - <i>Finer Features / channels possible</i> Contra - <i>Expensive equipment, comparable to Vat Photo Polymerisation equipment</i> - <i>Anisotropic microstructure</i> Patents - <i>Pending 1x</i>

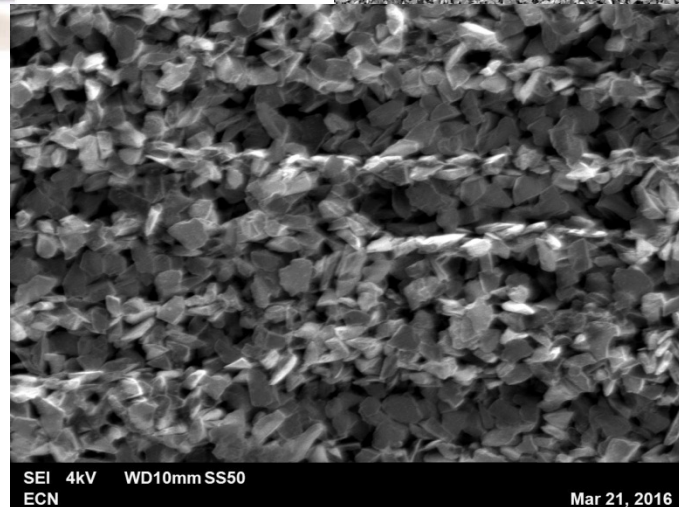
SiC and (Si₃N₄)



Photo Polymerisation SiC- ECN



Mar 21, 2016



SiC after de-binding- ECN

Conclusion

- AM processes for Metals by
 - Liquid solidification (melted droplets)
 - (spot) welding (selective laser melting)
 - Thermal spraying (preheated powder deposition / impact)
 - Sintering
- Best AM metals by sintering!

A production process comparable to PM Steel production and /or Metal Injection
Moulding possible by VAT polymerization / DLP even for Metals
- AM of non oxidic ceramics (SiC and Si₃N₄) feasible by DLP
- Production speeds of cm / hour (full area) are realistic

Thank you for your attention

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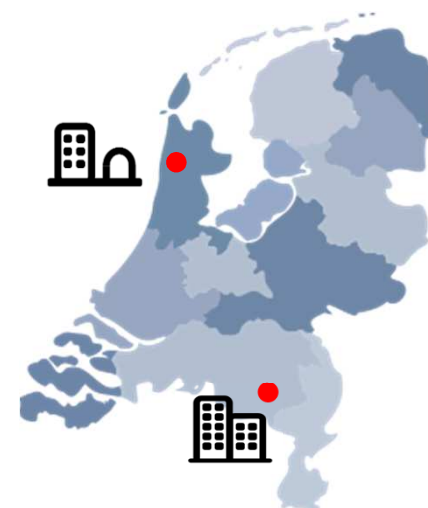
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Solliance Building – HTC21

How can we be of service to you?

What we do

Problem solving

Using our knowledge, technology, and facilities to solve our clients' issues

Technology development

Developing technology into prototypes and industrial applications

Engineering & Production

Realizing Parts, Equipment and Services based on our competences and facilities

How we can work with you

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Serving your short-term business and R&D needs

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Technology development & Transfer

Implement our technology in products & processes

Joint Industry Projects and Joint Ventures

Making tomorrow's technology available together

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